

# Analog Devices Welcomes Hittite Microwave Corporation

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### Typical Applications

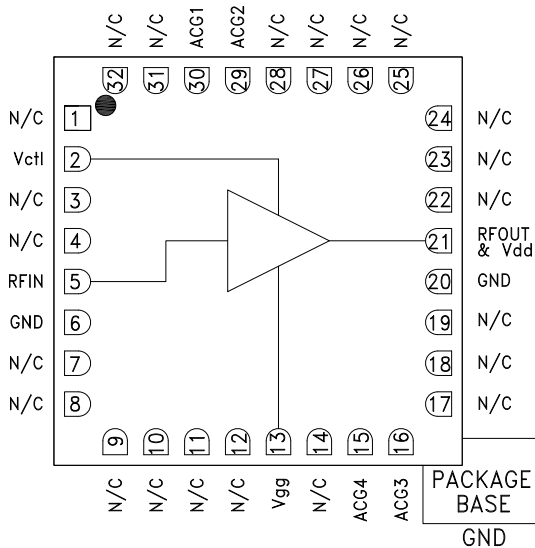
The HMC870LC5 is ideal for:

- 10 Gbps NRZ MZ & Low  $V_{\pi}$  Modulator Driver
- 10 Gbps RZ Transmission
- 40 Gbps DQPSK
- Broadband Gain Block for Test & Measurement Equipment
- Military & Space

### Features

- Wide Supply Range from 3.3V to 7V
- Adjustable Output Amplitude: 2.5 to 8 Vp-p
- Low Additive RMS Jitter, <300 fs
- Low DC Power Consumption  
1W for  $V_{out} = 8$  Vp-p at  $V_{dd} = 7V$
- Cross Point Adjustment
- 32 Lead 5x5mm SMT Package: 25mm<sup>2</sup>

### Functional Diagram



### General Description

The HMC870LC5 is a GaAs MMIC pHEMT Distributed Driver Amplifier packaged in a leadless 5x5 mm surface mount package which operates between DC and 20 GHz. The amplifier provides 17 dB of gain, 8Vp-p saturated output swing and features output swing cross point adjustment. Gain flatness is excellent at  $\pm 0.5$  dB as well as very low additive RMS jitter of 300 fs for 10 Gbps operation. HMC870LC5 provides Metro and Long Haul designers with scalable power dissipation for varying output drive requirements. (<0.4W at  $V_{out} = 3.6$  Vp-p and <1W at  $V_{out} = 8.5$  Vp-p) The HMC870LC5 has a very wide supply ( $V_{dd}$ ) operating range from +3.3V to +7V, and the RF I/Os are internally matched to 50 Ohms.

### Electrical Specifications, $T_A = +25^\circ C$ , $V_{dd} = 7V$ , $V_{ctl} = 1V$ , $I_{dd} = 165mA^*$

Parameter	Conditions	Min.	Typ.	Max.	Units
Gain	Frequency = 1 - 8 GHz	14	17.5		dB
	Frequency = 8 - 16 GHz	13	16.5		dB
	Frequency = 16 - 20 GHz	12	16		dB
Small Signal Bandwidth	3-dB cutoff		20		GHz
Input Return Loss	Frequency = 1 - 10 GHz		20		dB
	Frequency = 10 - 20 GHz		15		dB
Output Return Loss	Frequency = 1 - 10 GHz		20		dB
	Frequency = 10 - 20 GHz		15		dB
Gain Variation over Temperature	Frequency = 1 - 10 GHz		0.015	0.02	dB/ $^\circ C$
	Frequency = 10 - 20 GHz		0.032	0.045	dB/ $^\circ C$
Group Delay Variation	Frequency = 1 - 12 GHz		$\pm 15$		ps
Saturated Output Power ( $P_{sat}$ )	Frequency = 1 - 12 GHz		24		dBm
	Frequency = 12 - 20 GHz		23		dBm

\* Adjust  $V_{gg}$  between -2V to 0V to achieve  $I_{dd} = 165$  mA typical.

### Electrical Specifications, $T_A = +25^\circ\text{C}$ , $V_{dd} = 7\text{V}$ , $V_{ctl} = 1\text{V}$ , $I_{dd} = 165\text{mA}^*$ Continued

Parameter	Conditions	Min.	Typ.	Max.	Units
Output Power for 1 dB Compression (P1dB)	Frequency = 1 - 12 GHz	19	22		dBm
	Frequency = 12 - 20 GHz	18	21		dBm
Rise Time [1]	20% - 80%		20		ps
Fall Time [1]	20% - 80%		20		ps
Additive RMS Jitter [2]				300	fs
Supply Current (I <sub>dd</sub> ) (V <sub>gg</sub> = -0.6V Typ.)			165		mA
Bias Current Adjust (V <sub>gg</sub> )		-2		0	V
Output Voltage Adjust (V <sub>ctl</sub> )		0		2	V

[1] Data input = 22.5 Gbps NRZ PRBS 2<sup>23</sup>-1 pattern, 1.2 Vp-p.

[2] RMS jitter is calculated with 22.5 Gbps 10101... pattern.

\* Adjust V<sub>gg</sub> between -2V to 0V to achieve I<sub>dd</sub> = 165 mA typical.

### Electrical Specifications, $T_A = +25^\circ\text{C}$ , $V_{dd} = 5\text{V}$ , $V_{ctl} = 1\text{V}$ , $I_{dd} = 140\text{mA}^*$

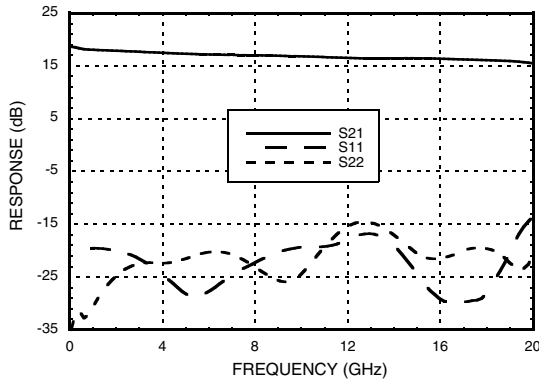
Parameter	Conditions	Min.	Typ.	Max.	Units
Gain	Frequency = 1 - 8 GHz	14	17.5		dB
	Frequency = 8 - 16 GHz	13.5	17.0		dB
	Frequency = 16 - 20 GHz	12	16.5		dB
Small Signal Bandwidth	3-dB cutoff		20		GHz
Input Return Loss	Frequency = 1 - 10 GHz		20		dB
	Frequency = 10 - 20 GHz		15		dB
Output Return Loss	Frequency = 1 - 10 GHz		15		dB
	Frequency = 10 - 20 GHz		10		dB
Gain Variation over Temperature	Frequency = 1 - 10 GHz		0.016	0.02	dB/°C
	Frequency = 10 - 20 GHz		0.029	0.045	dB/°C
Group Delay Variation	Frequency = 1 - 12 GHz		±15		deg
Saturated Output Power (P <sub>sat</sub> )	Frequency = 1 - 12 GHz		22.5		dBm
	Frequency = 12 - 20 GHz		22		dBm
Output Power for 1 dB Compression (P1dB)	Frequency = 1 - 12 GHz	18	20.5		dBm
	Frequency = 12 - 20 GHz	17	20		dBm
Rise Time [1]	20% - 80%		20		ps
Fall Time [1]	20% - 80%		20		ps
Additive RMS Jitter [2]				300	fs
Supply Current (I <sub>dd</sub> ) (V <sub>gg</sub> = -0.6V Typ.)			140		mA
Bias Current Adjust (V <sub>gg</sub> )		-2		0	V
Output Voltage Adjust (V <sub>ctl</sub> )		0		2	V

[1] Data input = 22.5 Gbps NRZ PRBS 2<sup>23</sup>-1 pattern, 1.2 Vp-p.

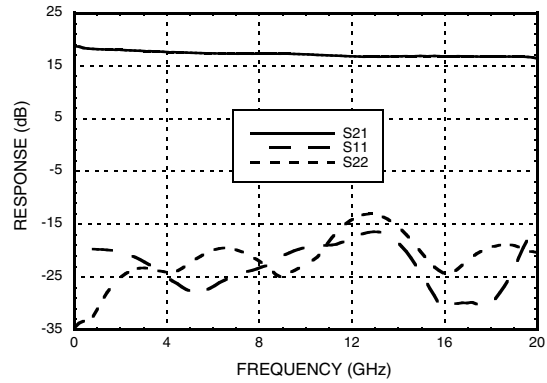
[2] RMS jitter is calculated with 22.5 Gbps 10101... pattern.

\* Adjust V<sub>gg</sub> between -2V to 0V to achieve I<sub>dd</sub> = 140 mA typical.

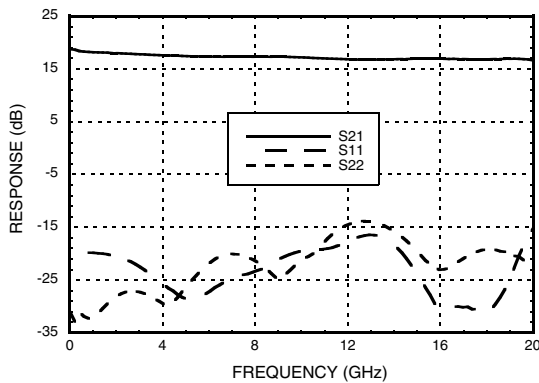
**Gain & Return Loss @ Vdd = 7V**



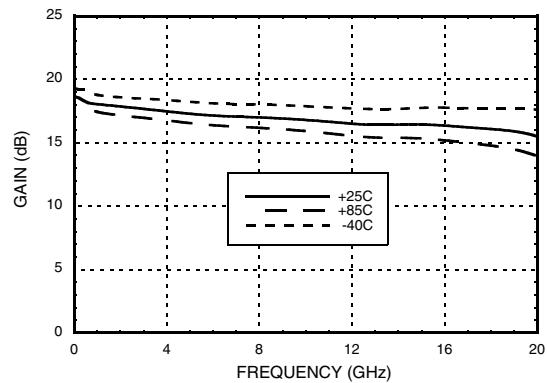
**Gain & Return Loss @ Vdd = 5V**



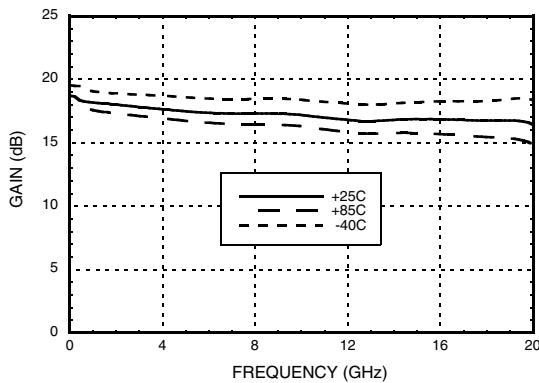
**Gain & Return Loss @ Vdd = 3.3V**



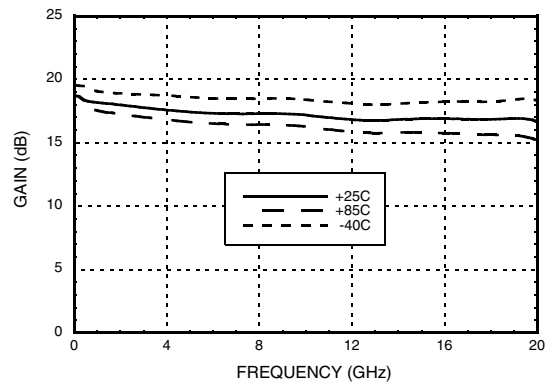
**Gain vs. Temperature @ Vdd = 7V**



**Gain vs. Temperature @ Vdd = 5V**



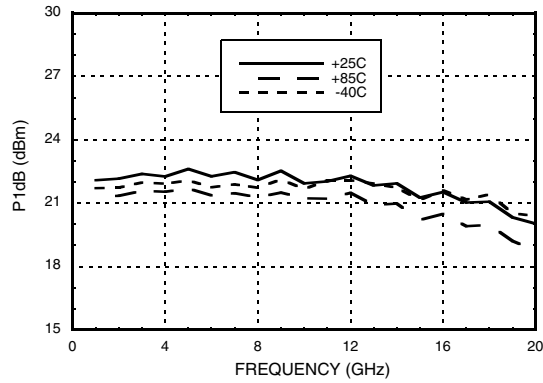
**Gain vs. Temperature @ Vdd = 3.3V**



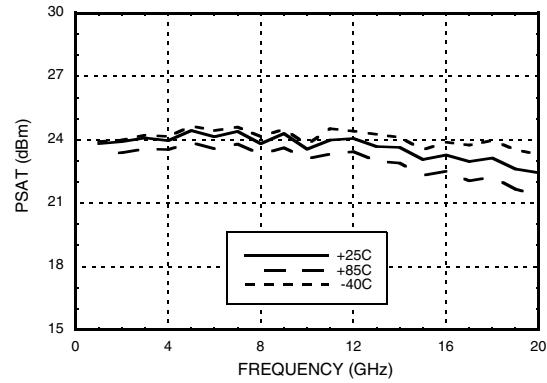


**MZ OPTICAL MODULATOR DRIVER, DC - 20 GHz**

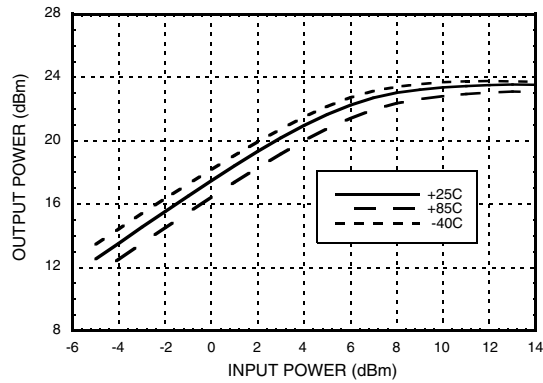
**P1dB vs. Temperature @ Vdd = 7V**



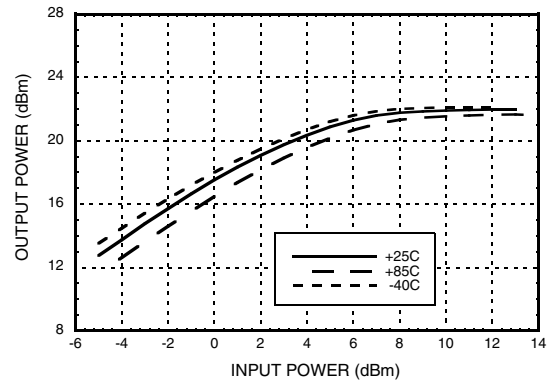
**Psat vs. Temperature @ Vdd = 7V**



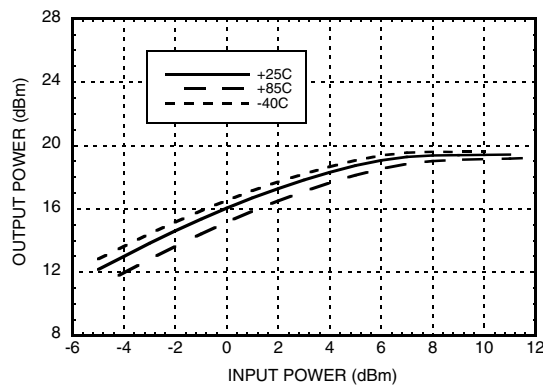
**Output Power vs. Input Power @ 10 GHz, Vdd = 7V**



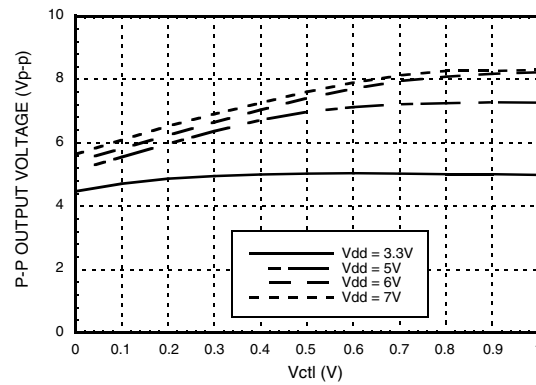
**Output Power vs. Input Power @ 10 GHz, Vdd = 5V**



**Output Power vs. Input Power @ 10 GHz, Vdd = 3.3V**

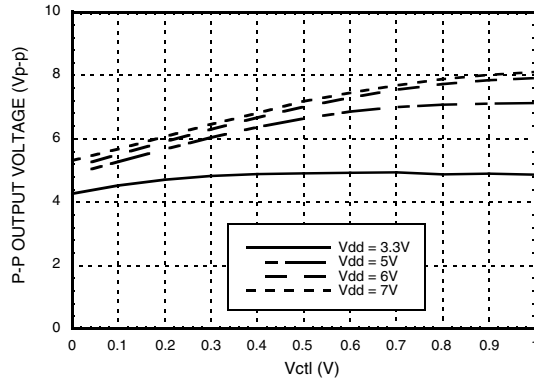


**Peak-to-Peak Output Voltage vs. Vdd @ 11.25 Gbps [1]**

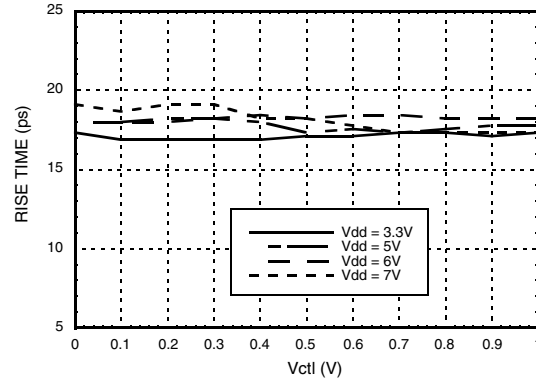


[1] Data input = 11.25 Gbps NRZ PRBS 2<sup>23</sup>-1 pattern, 1.2 Vp-p.

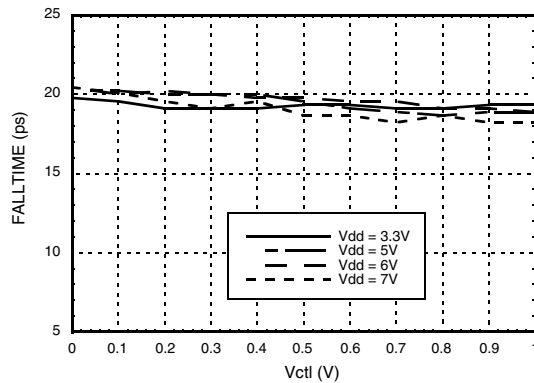
**Peak-to-Peak Output Voltage vs. Vdd @ 22.5 Gbps [1]**



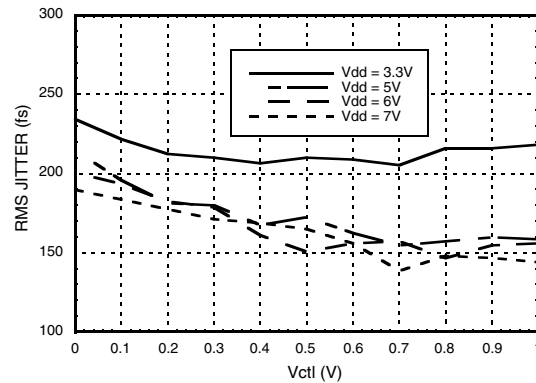
**Rise Time vs. Vdd @ 22.5 Gbps [1]**



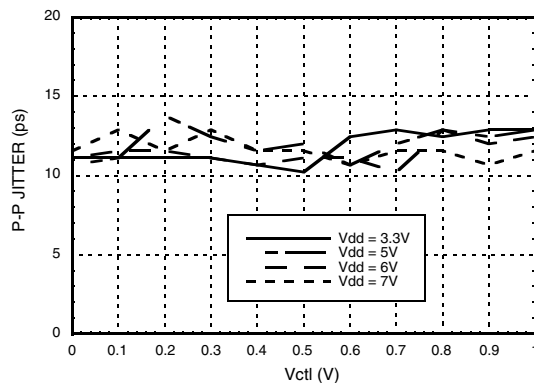
**Fall Time vs. Vdd @ 22.5 Gbps [1]**



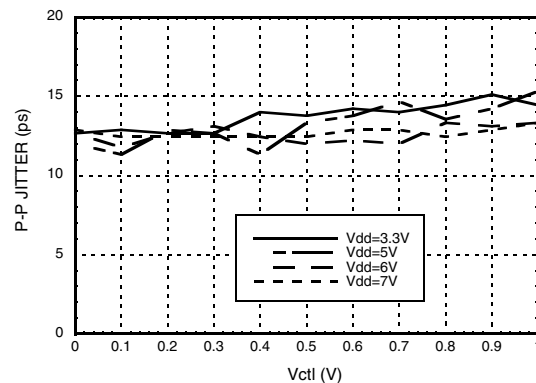
**RMS Jitter vs. Vdd @ 22.5 Gbps [2]**



**Peak-to-Peak Jitter vs. Vdd @ 11.25 Gbps [3][4]**



**Peak-to-Peak Jitter vs. Vdd @ 22.5 Gbps [1][4]**



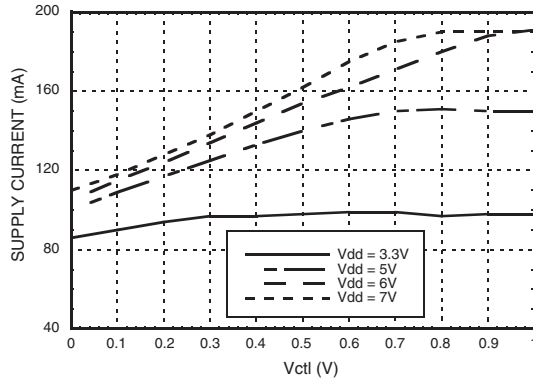
[1] Data input = 22.5 Gbps NRZ PRBS 2<sup>23</sup>-1 pattern, 1.2 Vp-p.

[2] RMS jitter is measured with 22.5 Gbps 10101... pattern.

[3] Data input = 11.25 Gbps NRZ PRBS 2<sup>23</sup>-1 pattern, 1.2 Vp-p.

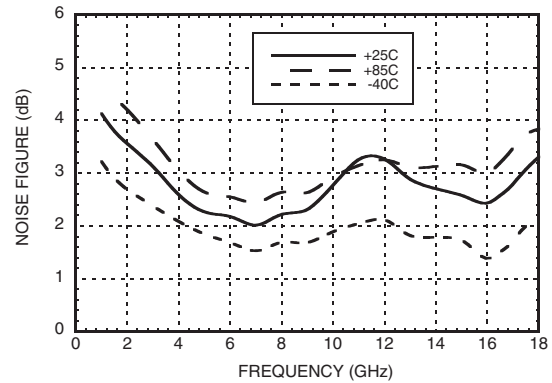
[4] Source jitter was not de-embedded.

### Supply Current vs. Vdd @ 22.5 Gbps [1]

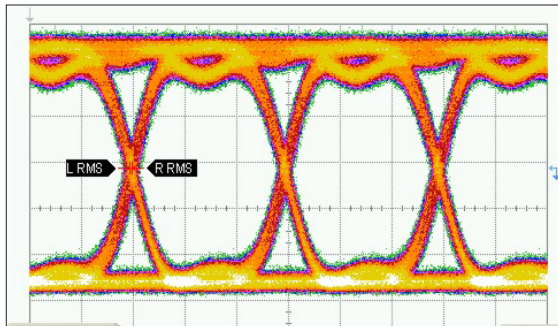


[1] Data Input = 22.5 Gbps NRZ PRBS 223-1 pattern, 1.2 Vp-p

### Noise Figure vs. Temperature @ Vdd = 7V



### 11.25 Gbps NRZ Output Eye Diagram

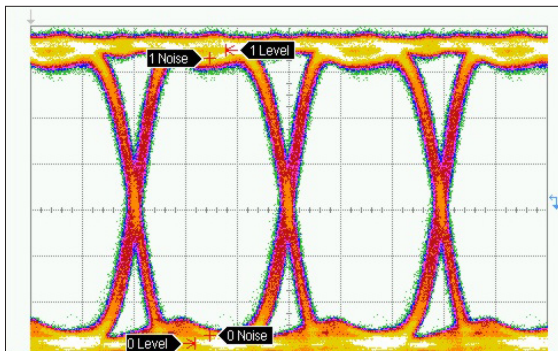


	Measurements			Units
	Current	Min	Max	
Eye Amplitude	3.6	3.6	3.6	V
Rise Time	20	20	20	ps
Fall Time	21.33	20.67	22	ps
Jitter RMS	1.893	1.87	2.072	ps

Time scale: 30.0 ps/div  
Amplitude scale: 762 mV/div

Vdd = 3.3V, Vin: 11.25 Gbps NRZ PRBS 2<sup>31</sup>-1, 0.5 Vp-p  
Vout: 3.6Vp-p  
Vctl = 1V

### 11.25 Gbps NRZ Output Eye Diagram



	Measurements			Units
	Current	Min	Max	
Eye Amplitude	7.47	7.47	7.47	V
SNR	17.97	17.88	18.12	V/V

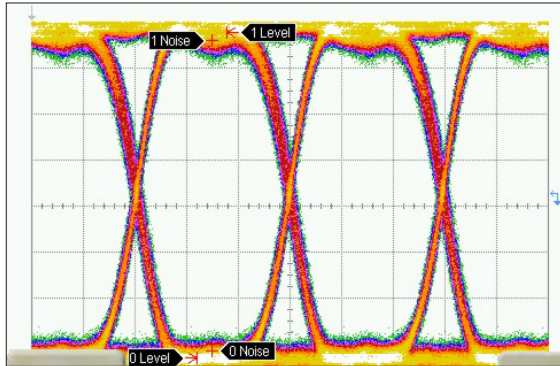
Time scale: 30.0 ps/div  
Amplitude scale: 1.17 V/div

Vdd = 5V, Vin: 11.25Gbps NRZ PRBS 2<sup>31</sup>-1, 1.2V p-p,  
Vout: 7.5Vp-p  
Vctl = 1V



## MZ OPTICAL MODULATOR DRIVER, DC - 20 GHz

### 11.25 Gbps NRZ Output Eye Diagram (Continued)

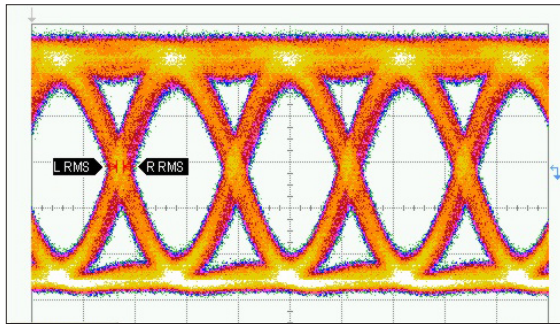


	Measurements			Units
	Current	Min	Max	
Eye Amplitude	8.26	8.26	8.27	V
SNR	22.35	22.26	22.51	V/V

Time scale: 30.0 ps/div  
Amplitude scale: 1.17 V/div

Vdd = 7V, Vin: 11.25Gbps NRZ PRBS 2<sup>31</sup>-1, 1.2V p-p,  
Vout: 8.3Vp-p  
Vctl = 1V

### 22.5 Gbps NRZ Output Eye Diagram

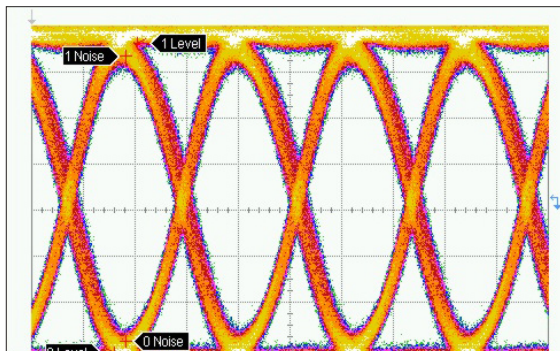


	Measurements			Units
	Current	Min	Max	
Eye Amplitude	3.53	3.53	3.54	V
Rise Time	18.22	17.33	18.22	ps
Fall Time	20.44	19.56	20.89	ps
Jitter RMS	2.417	2.187	2.422	ps

Time scale: 20.0 ps/div  
Amplitude scale: 762 mV/div

Vdd = 3.3V, Vin: 22.5Gbps NRZ PRBS 2<sup>31</sup>-1, 0.5V p-p,  
Vout: 3.5Vp-p  
Vctl = 1V

### 22.5 Gbps NRZ Output Eye Diagram

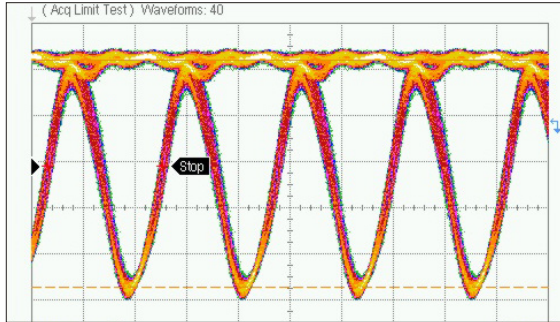


	Measurements			Units
	Current	Min	Max	
Eye Amplitude	7.85	7.84	7.85	V
SNR	13.74	13.69	14.07	V/V

Time scale: 20.0 ps/div  
Amplitude scale: 1.17 V/div

Vdd = 7V, Vin: 22.5Gbps NRZ PRBS 2<sup>31</sup>-1, 1.2 V p-p,  
Vout: 7.9Vp-p  
Vctl = 1V

### 11.25 Gbps RZ Output Eye Diagram

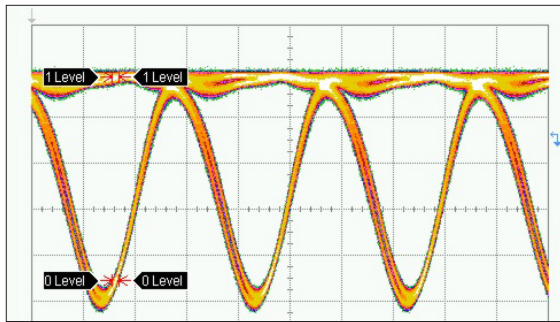


	Measurements	
	Current	Units
Jitter RMS	1.93	ps
Bit Rate	11.2	Gb/s

Time scale: 40.0 ps/div  
Amplitude scale: 1.22 V/div

Vdd = 3.3V, Vin: 11.25Gbps RZ PRBS 2<sup>31</sup>-1, 0.3V p-p,  
Vout: 2.9Vp-p  
Vctl = 1V

### 11.25 Gbps RZ Output Eye Diagram



	Measurements			
	Current	Min	Max	Units
Duty Cycle	51.5	50.4	57.1	%
SNR	20.85	13.35	20.96	V/V
Jitter RMS	1.753	1.689	1.795	ps
Eye Amplitude	2.85	2.37	2.86	V

Time scale: 30.0 ps/div  
Amplitude scale: 647 mV/div

Vdd = 5V, Vin: 11.25Gbps RZ PRBS 2<sup>31</sup>-1, 1.2V p-p,  
Vout: 6Vp-p  
Vctl = 1V

### Absolute Maximum Ratings

Drain Bias Voltage (Vdd)	+9V
Gate Bias Voltage (Vgg)	-2V to 0V
Control Bias Voltage (Vctl)	(Vdd -7) to Vdd (V)
RF Input Power (RFIN)(Vdd = +7 Vdc)	+23 dBm
Channel Temperature	175 °C
Continuous Pdiss (T = 85 °C) (derate 24 mW/°C above 85 °C)	1.5 W
Thermal Resistance (channel to ground paddle)	59.4 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A

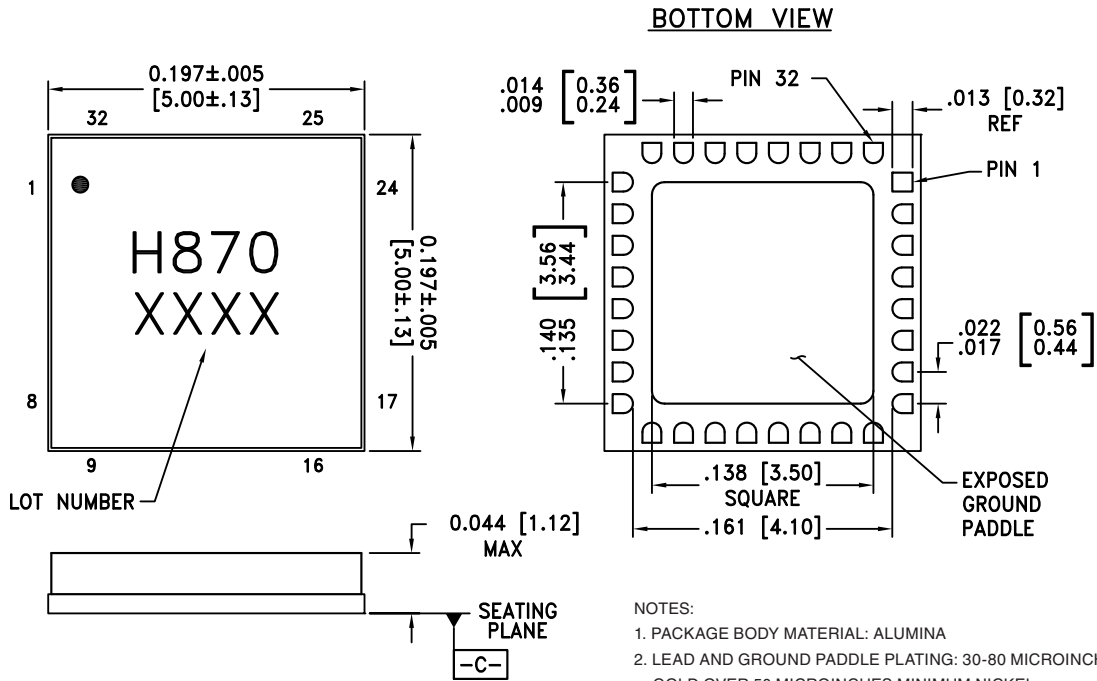
### Typical Supply Current vs. Vdd\*

Vdd (V)	Idd (mA)*	Power Dissipation (W)
+3.3	100	0.33
+5.0	140	0.70
+6.0	160	0.96
+7.0	165	1.115

\* Adjust Vgg between -2V to 0V to achieve Idd shown.



ELECTROSTATIC SENSITIVE DEVICE  
OBSERVE HANDLING PRECAUTIONS

**Outline Drawing**


- NOTES:
1. PACKAGE BODY MATERIAL: ALUMINA
  2. LEAD AND GROUND PADDLE PLATING: 30-80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKEL.
  3. DIMENSIONS ARE IN INCHES [MILLIMETERS].
  4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
  5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM [-C-]
  6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.

**Package Information**

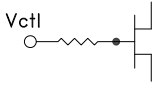
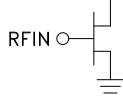

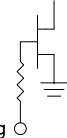
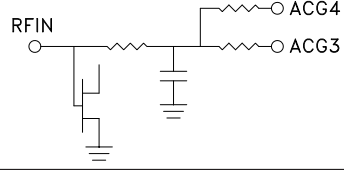
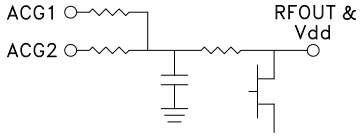
Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking <sup>[2]</sup>
HMC870LC5	Alumina, White	Gold over Nickel	MSL3 <sup>[1]</sup>	H870 XXXX

[1] Max peak reflow temperature of 260 °C

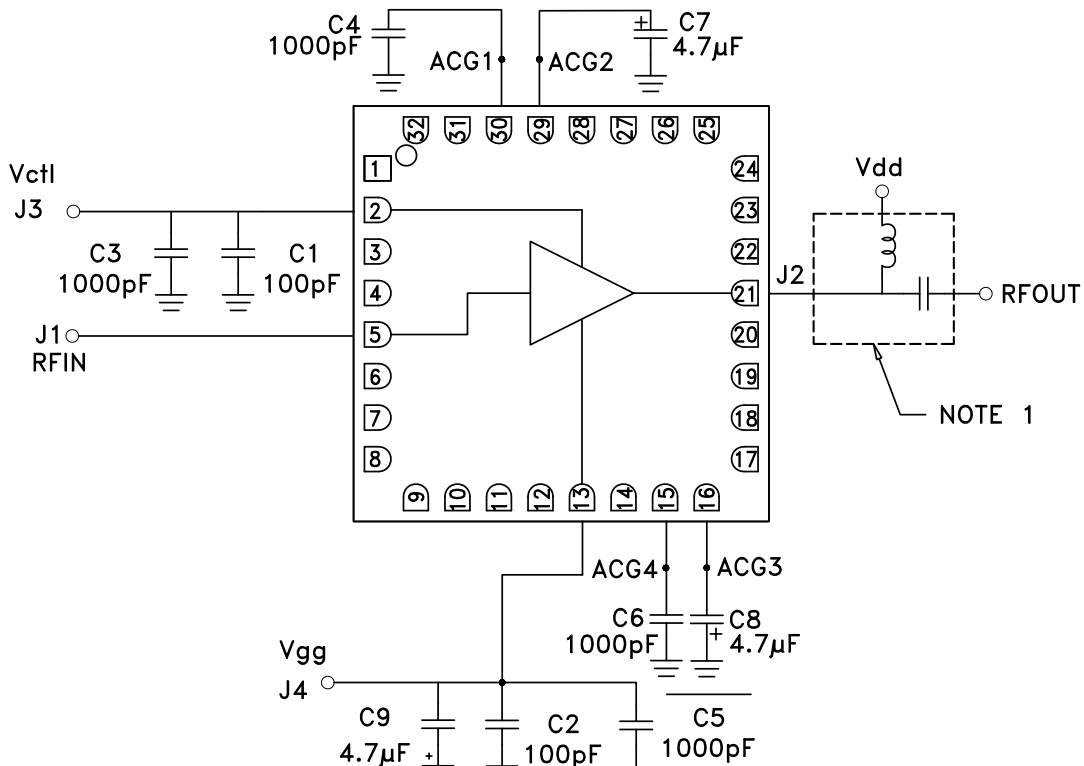
[2] 4-Digit lot number XXXX



### Pin Descriptions

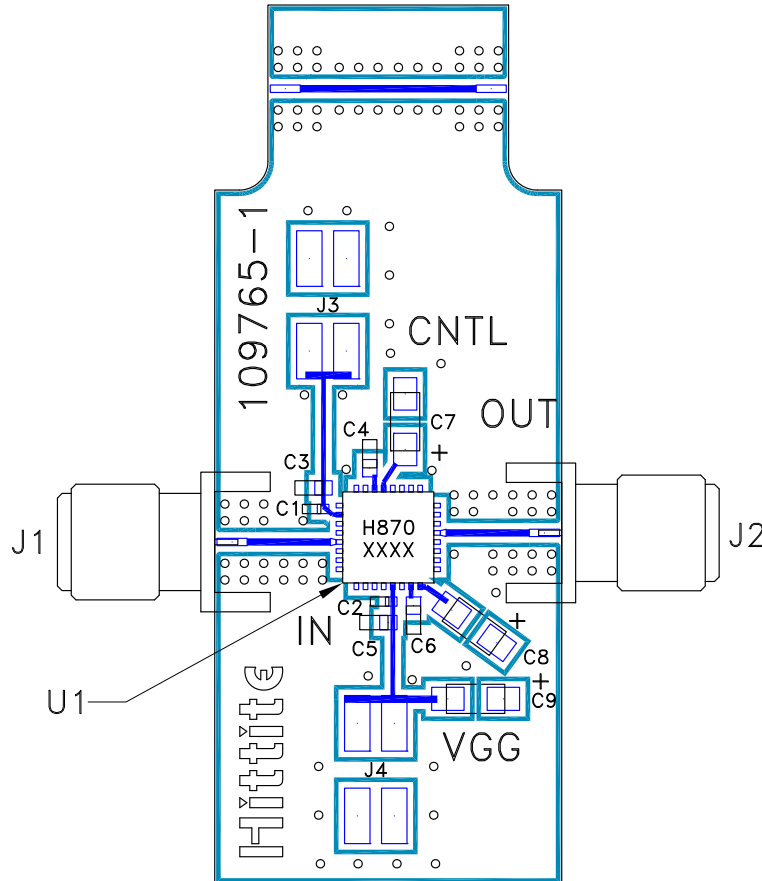
Pin Number	Function	Description	Interface Schematic
1, 3, 4, 7 - 12, 14, 17 - 19, 22 - 28, 31, 32	N/C	The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
2	Vctl	Output voltage swing adjustment. +1V should be applied to Vctl for nominal operation.	
5	RFIN	This pin is DC coupled and matched to 50 Ohms.	
6, 20	GND	RF/DC Ground. These pins and the package base must be connected to RF/DC ground.	
13	Vgg	Gate Control for amplifier.	
15	ACG4	Low frequency termination. Attach bypass capacitor per application circuit herein.	
16	ACG3		
21	RFOUT & Vdd	RF output for amplifier. Connect the DC bias (Vdd) network to provide drain current (Idd). See application circuit herein.	
29	ACG2	Low frequency termination. Attach bypass capacitor per application circuit herein.	
30	ACG1		

### Application Circuit



NOTE 1: Drain Bias (Vdd) must be applied through a broadband bias tee or external bias network.

### Evaluation PCB



### List of Materials for Evaluation PCB 108347 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3 - J4	2mm Molex Header
C1, C2	100 pF Capacitor, 0402 Pkg.
C3 - C6	1000 pF Capacitor, 0603 Pkg.
C7 - C9	4.7 μF Capacitor, Tantalum
U1	HMC870LC5, Modulator Driver
PCB [2]	109765 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Arlon 25FR or Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and package bottom should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.



MICROWAVE CORPORATION v05.0614



## HMC870LC5

### MZ OPTICAL MODULATOR DRIVER, DC - 20 GHz

#### **Device Operation**

These devices are susceptible to damage from Electrostatic Discharge. Proper precautions should be observed during handling, assembly and test.

The input to this device should be AC-coupled. To provide the typical 8Vp-p output voltage swing, a 1.2Vp-p AC-coupled input voltage swing is required.

#### **Device Power Up Instructions**

1. Ground the device
  2. Set V<sub>gg</sub> to -2V (no drain current)
  3. Set V<sub>ctl</sub> to +1V (no drain current)
  4. Set V<sub>dd</sub> to +5V (no drain current)
  5. Adjust V<sub>gg</sub> for I<sub>dd</sub> = 140mA
- V<sub>gg</sub> may be varied between -1V and 0V to provide the desired eye crossing point percentage (i.e. 50% crosspoint) and a limited cross point control capability.
  - V<sub>dd</sub> may be increased to +7V if required to achieve greater output voltage swing.
  - V<sub>ctl</sub> may be adjusted between +2V and +0V to vary the output voltage swing.

#### **Device Power Down Instructions**

1. Reverse the sequence identified above in steps 1 through 4.





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